# Design Guide: TIDA-010058 5-V/2-A, 12-V/2.5-A Dual-Output Flyback Reference Design With < 50-mW Standby Power

# TEXAS INSTRUMENTS

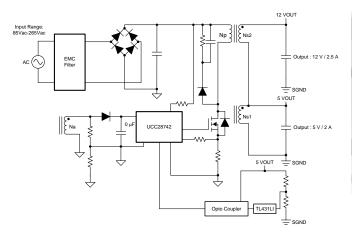
#### Description

This reference design is a dual-output flyback converter using secondary-side regulation based on the UCC28742. A 5-V rail is regulated within  $\pm$ 1% precision and a cross regulation of a 12-V rail is within -8% to +14% at 25% to 100% load. The design utilizes a single-layer PCB for cost optimization. The peak efficiency is 82.82% at 115 V/50 Hz and 83.19% at 230 V/50 Hz. Power consumption at standby mode is 31.6 mW at 115 V/50 Hz and 54.2 mW at 230 V/50 Hz.

#### Resources

TIDA-010058 UCC28742 TL431 Design Folder Product Folder Product Folder





#### Features

- < 50-mA standby power consumption for 50-W power supply applications
- Optocoupler feedback delivers fast transient response and tight voltage regulation
- DCM operation with valley switching for improved efficiency and reduced EMI
- Ultra-low startup current and large VDD hysteresis for low bias capacitance
- Fault protections, including input low line, output overvoltage, overcurrent, and short-circuit protection

#### Applications

- Cooking top
- Washer & dryer
- Residential air conditioners
- Coffee machine
- Air purifier & humidifier





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#### 1 System Description

Standby power is electricity used by appliances and equipment while switched off or not performing primary functions. Standby power is also used by circuits that are continually energized even when the device is turned off.

Under the Energy-Using Product (EuP) directive, the commission sets maximum limits for passive standby and off-mode power. The objective of the eco-design requirements for standby and off mode is to ensure the lowest possible energy use for household appliances and electronic products. The main requirement is that standby power of an appliance system without a display must not consume more than 0.5 W, and the standby power of an appliance system with an information display must not consume more than 1 W. The EU directive is expected to change from 500-mW to 300-mW standby power following the release of this design, making it difficult for new functions, such as Wi-Fi®, large displays, and drive power requirements for the active state up, to achieve the new standby power target. A solution is a lower bias power supply for cost-effective total system standby power consumption with no cost increase to the bill of materials (BOM).

#### 1.1 Key System Specifications

PARAMET	TER	TEST CONDITIONS	MINIMUM	TYPICAL	MAXIMUM	UNIT
INPUT CH	ARACTERISTICS		-		U	
V <sub>IN</sub>	AC-line input voltage		85	220	265	VRMS
f <sub>LINE</sub>	Line frequency		47	50	63	Hz
P <sub>STBY</sub>	No-load input power	V <sub>IN</sub> =typ, I <sub>O</sub> =0A			50	mW
OUTPUT (	CHARACTERISTICS					
V <sub>01</sub>	DC output voltage 1	$V_{IN} = typ, I_{O} = 0 \text{ to IOR}$		5		V
$V_{RIPPLE1}$	Output voltage ripple 1	$V_{IN} = typ, I_O = IOR$			50	mV
I <sub>OR1</sub>	Output rated current 1	V <sub>IN</sub> = min to max		2		A
VO2	DC output voltage 2	$V_{IN} = typ$ , $I_O = 0$ to $I_{OR}$		12		V
$V_{RIPPLE2}$	Output voltage ripple 2	$V_{IN} = typ, I_O = I_{OR}$			100	mV
I <sub>OR2</sub>	Output rated current 2	V <sub>IN</sub> = min to max		2.5		А
η	Average efficiency	V <sub>IN</sub> = typ, average of 25%, 50%,75%, and 100% Load			83.5	%
SYSTEMS	CHARACTERISTICS			H	4	ļ
f <sub>sw</sub>	Switching frequency				100	kHz

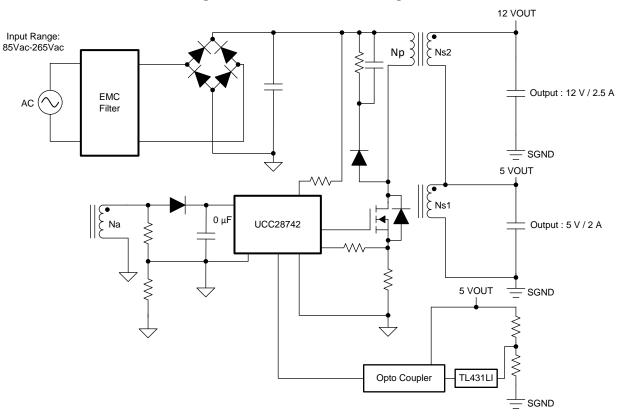
#### Table 1. TIDA-010058 Electrical Performance Specifications



#### 2 System Overview

#### 2.1 Block Diagram

Figure 1 shows the high-level block diagram of the circuit. The main parts of this reference design are the isolated flyback power supply controller (UCC28742) and the adjustable precision shunt regulator with optimized reference current (TL431LI).





#### 2.2 Design Considerations

Most industrial applications require a bias power supply and have at least dual power rails for the entire system: 3.3 V or 5 V for the system controller and 12 V or 15 V for the power module. This reference design provides dual isolated outputs of 5 V with 2 A and 12 V with 2.5 A that cover most industrial applications. This design also achieves very low power consumption in standby mode. The design is suited for use in isolated offline systems requiring low standby power, high efficiency, and low BOM cost.

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#### 2.3 Highlighted Products

This reference design features the following devices, which are selected based on their specifications and cost consideration. For more information on each of these devices, see their respective product folders at TI.com or click on the links for the product folders under Resources.

#### 2.3.1 UCC28742

The UCC28742 is a flyback power-supply controller which provides high-performance voltage regulation using an optically coupled feedback signal from a secondary-side voltage regulator. The device provides accurate constant-current regulation using primary-side feedback. The controller operates in discontinuous-conduction mode (DCM) with valley-switching to minimize switching losses and allow for the use of low cost output rectifiers. The control law scheme combines frequency with primary peak-current amplitude modulation to provide high conversion efficiency across the load range. The control law provides a wide dynamic operating range of output power which allows the power-supply designer to achieve low standby power dissipation. During low-power operating conditions, the power-management features of the controller reduce the device operating current at switching frequencies below 25 kHz. At and above this frequency, the UCC28742 includes features in the modulator to reduce the EMI peak energy of the fundamental switching frequency and harmonics. A complete low-cost and low component-count solution is realized using a straight-forward design process.

#### 2.3.2 TL431LI

This standard device has proven ubiquity and versatility across a wide range of applications, ranging from power to signal path. This is due to its key components containing an accurate voltage reference and op amp, which are very fundamental analog building blocks. TL43xLI is used in conjunction with it's key components to behave as a single voltage reference, error amplifier, voltage clamp or comparator with integrated reference. TL43xLI can be operated and adjusted to cathode voltages from 2.495V to 36V, making this part optimum for a wide range of end equipments in industrial, auto, telecom and computing. In order for this device to behave as a shunt regulator or error amplifier, >1mA (Imin(max)) must be supplied in to the cathode pin. Under this condition, feedback can be applied from the Cathode and Ref pins to create a replica of the internal reference voltage. Various reference voltage options can be purchased with initial tolerances (at 25°C) of 0.5%, and 1%. These reference options are denoted by B (0.5%) and A (1.0%) after the TL431LI or TL432LI. TL431LI and TL432LI are both functionally the same, but have separate pinout options. The TL43xLIxC devices are characterized for operation from 0°C to 70°C, the TL43xLIxI devices are characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C, and the TL43xLIxQ devices are characterized for operation from  $-40^{\circ}$ C.

#### 2.4 System Design Theory

During voltage regulation (CV mode), the UCC28742 operates in frequency modulation mode and peak current amplitude modulation mode.

The UCC28742 internally limits its operating frequency between  $f_{SW(min)}$  and  $f_{SW(max)}$ , typically between 200 Hz and 105 kHz. The choice of transformer primary inductance and primary-peak current sets the maximum operating frequency of the converter, which must be equal to or lower than  $f_{SW(max)}$ . Conversely, the choice of maximum target operating frequency and primary-peak current determines the transformer primary-inductance value. The actual minimum switching frequency for any particular converter depends on several factors, including minimum loading level, leakage inductance losses, switch-node capacitance losses, other switching and conduction losses, and bias-supply requirements.

Figure 2 shows the typical application circuit for the UCC28742, in which the key components that must be calculated are current sense resistor  $R_{CS}$  (R11 and R14), VDD capacitance  $C_{DD}$  (C3), VDD start-up resistance  $R_{STR}$  (R4, R5 and R6), VS resistor divider (R17 and R18), and the transformer.

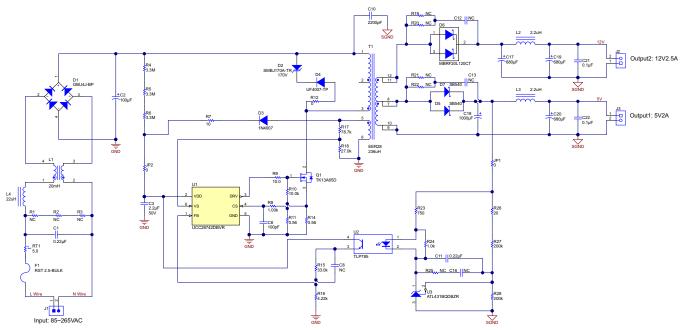


Figure 2. Typical Application Circuit for the UCC28742

#### 2.4.1 Current Sense Resistor

The current sense pin is connected through a series resistor to the current-sense resistor ( $R_{cs}$ ). The controller varies the internal current sense threshold between 190 mV and 770 mV. The values of  $R_{cs}$  can be determined by Equation 1. The term  $\eta_{xFMR}$  is intended to account for the energy stored in the transformer but not delivered to the secondary. This includes transformer core and copper losses, bias power, and primary leakage inductance losses.

$$R_{CS} = \frac{V_{CCR} \times N_{PS}}{2 \times I_{OCC}} \times \sqrt{\eta_{XFMR}}$$

(1)

Where,

- V<sub>CCR</sub> is a current regulation constant with a typical value of 363 mV
- N<sub>PS</sub> is the transformer primary-to-secondary turns ratio
- I<sub>occ</sub> is the target output current in constant-current limit
- $\eta_{XFMR}$  is the transformer efficiency

#### 2.4.2 VDD Capacitance, C<sub>DD</sub>

The capacitance on VDD must supply the device operating current until the output of the converter reaches the target minimum operating voltage. At this time, the auxiliary winding can sustain the voltage to the UCC28742. The total output current available to the load and to charge the output capacitors is the constant current regulation target. Equation 2 assumes the output current of the flyback is available to charge the output capacitance until the minimum output voltage is achieved to maintain VDD above its  $V_{VDD(on)}$ . The gate drive current depends on a particular MOSFET to be used. With an estimated average of 1.0 mA of gate-drive current,  $C_{DD}$  is determined using Equation 2.

$$C_{DD} = \frac{\left(I_{RUN} + 1\,\text{mA}\right) \times \frac{C_{OUT} \times V_{OCV}}{I_{OCC}}}{\left(V_{DD(\text{on}).\text{min}} - V_{DD(\text{off}).\text{max}}\right)}$$

(2)

#### 2.4.3 VDD Start-Up Resistance R<sub>STR</sub>

Once the VDD capacitance is known, the start-up resistance from  $V_{BULK}$  to achieve the power-on delay time ( $t_{STR}$ ) target can be determined using Equation 3.

$$R_{STR} = \frac{\sqrt{2} \times V_{IN(min)}}{I_{START} + \frac{V_{DD(on)} \times C_{DD}}{t_{STR}}}$$

#### 2.4.4 VS Resistor Divider

The VS divider resistors determine the output voltage regulation point of the flyback converter. The highside divider resistor ( $R_{S1}$ ) determines the line voltage at which the controller enables continuous DRV operation.  $R_{S1}$  is initially determined based on the transformer auxiliary to primary turns-ratio and the desired input voltage operating threshold.  $R_{S1}$  can be calculated using Equation 4.

$$R_{S1} = \frac{V_{IN(run)} \times \sqrt{2}}{N_{PA} \times I_{VSL(run)}}$$
(4)

 $I_{VSL(run)}$  is VS pin run current with a typical value of 210  $\mu$ A for a design. The low-side VS pin resistor is selected based on desired output over voltage V<sub>ov</sub> and can be calculated using Equation 5.

$$R_{S2} = \frac{R_{S1} \times V_{OVP}}{N_{AS} \times (V_{OV} + V_F) - V_{OVP}}$$
(5)

#### 2.4.5 Transformer Turns Ratio N<sub>PS</sub>, Inductance L<sub>P</sub>, Primary-Peak Current I<sub>PP(MAX)</sub>

The maximum primary-to-secondary turns ratio can be determined by the target maximum switching frequency at full load, the minimum input capacitor bulk voltage, and the estimated DCM resonant time.

Determine the maximum available total duty cycle of the on time and secondary conduction time based on the target switching frequency and DCM resonant time. For DCM resonant time, assume 500 kHz if an estimate is not available from previous designs. For the transition mode operation limit, the period required from the end of secondary current conduction to the first valley of the V<sub>DS</sub> voltage is ½ of the DCM resonant period, or 1  $\mu$ s assuming 500-kHz resonant frequency. D<sub>MAX</sub> can be determined using Equation 6.

$$D_{MAX} = 1 - \left(\frac{t_R}{2} \times f_{MAX}\right) - D_{MAGCC}$$

Once  $D_{MAX}$  is known, the maximum turns ratio of the primary to secondary can be determined using Equation 7.  $D_{MAGCC}$  is defined as the secondary diode conduction duty cycle when load current reaches a specified limit operation. It is set internally by the UCC28742 at 0.475. The total voltage on the secondary winding needs to be determined, which is the sum of  $V_{OCV}$ , and the secondary rectifier,  $V_F$ .  $N_{PS}$ , can be determined using Equation 7.

$$N_{PS} = \frac{D_{MAX} \times V_{BULK(min)}}{D_{MAGCC} \times (V_{OCV} + V_F)}$$

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(3)

(6)

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 $N_{PS}$  is determined also with other design factors such as voltage and current ratings of the primary MOSFET, secondary rectifier diode, as well as the secondary MOSFET if the synchronous rectifier is used. Once an optimum turns ratio is determined from a detailed transformer design, use this ratio for the other parameters.

The primary transformer inductance and primary-peak current,  $I_{PP(MAX)}$ , can be calculated using the standard energy storage equation for flyback transformers. Primary current, maximum switching frequency, and output and transformer efficiency are included in Equation 8 and Equation 9.

The transformer primary current should be determined. Primary current is simply the maximum current sense threshold divided by the current sense resistance.

$$I_{PP(max)} = \frac{V_{CST(max)}}{R_{CS}}$$
$$L_{P} = \frac{2 \times (V_{OCV} + V_{F}) \times I_{OCC}}{\eta XFMR \times I_{PP(max)}^{2} \times f_{MAX}}$$

(8)

(9)

#### 3 Hardware, Testing Requirements, and Test Results

#### 3.1 Required Hardware

#### 3.1.1 Test Equipment Needed

- Chroma AC source MODEL 61603
- Chroma DC E-load MODEL 6314A
- Single-phase power meter WT210
- Tektronix DPO 3054
- Multimeter (current): Fluke 287C
- Multimeter (voltage): Fluke 287C
- Electrical thermography: Fluke TiS55
- EMI test receiver: KH3939

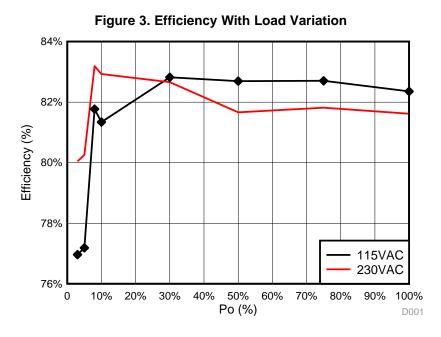
#### 3.1.2 Test Setup

- Connect the line of the AC source on the design input (pin 1 of connector J1), and connect the neutral of the AC source on the TIDA-010058 input (pin 2 of connector J1) through the current sensing module of the power meter.
- Connect the voltage sensing module to the design input (connector J1).
- Connect an electronic load to the 12-V output terminal (connector J2) with the load set to draw 30 W through the multimeter.
- Connect another electronic load to the 5-V output terminal (connector J3) with the load set to draw 10 W.
- Turn on the AC source connected to the design input with a universal input voltage (85-V to 264-V AC).
- Once the design activates, monitor the input power consumption and dual output performance.
- Turn off the AC source and disconnect the AC source from the board when the test is complete.



#### 3.2 Testing and Results

#### 3.2.1 Efficiency With Load Variation



#### 3.2.1.1 115-V AC/50-Hz Efficiency Measurement

#### Table 2. 115-V AC/50-Hz Efficiency Measurement

Vin (Vac)	LOAD (%)	PIN (W)	Vout1 (V)	lout1 (A)	Vout2 (V)	lout2 (A)	Pout (V)	η (%)
	3%	1.61	4.99	0.05	12.37	0.08	1.24	76.96%
	5%	2.74	4.99	0.1	12.43	0.13	2.11	77.19%
	8%	4.10	4.99	0.15	12.4	0.21	3.35	81.77%
115 V	10%	5.20	4.99	0.2	12.43	0.26	4.23	81.34%
115 V	30%	15.00	4.99	0.57	12.44	0.77	12.42	82.82%
	50%	24.60	4.98	0.92	12.41	1.27	20.34	82.69%
	75%	36.30	4.98	1.33	12.38	1.89	30.02	82.70%
	100%	47.60	4.97	1.7	12.35	2.49	39.20	82.35%

#### 3.2.1.2 230-V AC/50-Hz Efficiency Measurement

	Table 3. 230-V AC/50-HZ Efficiency Measurement										
Vin (Vac)	LOAD (%)	PIN (W)	Vout1 (V)	lout1 (A)	Vout2 (V)	lout2 (A)	Pout (V)	η (%)			
	3%	1.55	4.99	0.05	12.39	0.08	1.24	80.05%			
	5%	2.64	4.99	0.1	12.46	0.13	2.12	80.26%			
	8%	4.04	4.99	0.15	12.44	0.21	3.36	83.19%			
230 V	10%	5.11	4.99	0.2	12.46	0.26	4.24	82.93%			
230 V	30%	15.02	4.99	0.57	12.43	0.77	12.42	82.66%			
	50%	24.91	4.98	0.92	12.41	1.27	20.34	81.66%			
	75%	36.67	4.98	1.33	12.37	1.89	30.00	81.82%			
	100%	48.00	4.97	1.7	12.34	2.49	39.18	81.62%			

## Table 3. 230-V AC/50-Hz Efficiency Measurement

#### 3.2.2 **Cross Regulation**

#### 3.2.2.1 Cross Regulation Under 115-V AC/50 Hz

#### Table 4. Vin = 115 V, Vout1

LOAD 2 / LOAD 1	3%	5%	8%	10%	30%	50%	75%	100%
1%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
3%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
5%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
8%	4.99	0.99	4.99	4.99	4.99	4.99	4.99	4.99
10%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
30%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
50%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
75%	4.99	5	4.99	4.99	4.99	4.99	4.99	4.99
100%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99

#### Table 5. Vin = 115 V, Vout2

LOAD 2 / LOAD 1	3%	5%	8%	10%	30%	50%	75%	100%
1%	13.08	13.85	14.48	15.03	-	-	-	-
3%	12.39	12.74	13.06	13.35	15.21	-	-	-
5%	12.16	12.46	12.69	12.89	14.28	15.32	-	-
8%	11.9	12.26	12.44	12.58	13.61	14.38	-	-
10%	11.75	12.15	12.34	12.46	13.35	14.01	14.71	-
30%	-	11.29	11.63	11.83	12.49	12.8	13.14	13.43
50%	-	10.67	11.11	11.3	12.19	12.46	12.68	12.88
75%	-	10.07	10.58	10.9	11.91	12.21	12.41	12.55
100%	-	-	-	-	-	12.04	12.24	12.37

Hardware, Testing Requirements, and Test Results

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#### 3.2.2.2 Cross Regulation Under 230-V AC/50 Hz

LOAD 2 / LOAD 1	3%	5%	8%	10%	30%	50%	75%	100%
1%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
3%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
5%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
8%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
10%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
30%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
50%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99
75%	4.99	5	4.99	4.99	4.99	4.99	4.99	4.99
100%	4.99	4.99	4.99	4.99	4.99	4.99	4.99	4.99

#### Table 6. Vin = 230 V, Vout1

#### Table 7. Vin = 230 V, Vout2

LOAD 2 / LOAD 1	3%	5%	8%	10%	30%	50%	75%	100%
1%	13.08	13.87	14.54	15.1	-	-	-	-
3%	12.39	12.78	13.1	13.38	15.26	-	-	-
5%	12.15	12.48	12.7	12.9	14.26	-	-	-
8%	11.87	12.26	12.45	12.6	13.59	14.38	-	-
10%	11.71	12.14	12.35	12.48	13.34	14.02	14.72	-
30%	-	11.34	11.68	11.87	12.49	12.8	13.14	13.44
50%	-	-	11.17	11.43	12.19	12.45	12.69	12.9
75%	-	-	-	10.98	11.92	12.21	12.41	12.57
100%	-	-	-	-	11.7	12.03	12.24	12.38

#### 3.2.3 No-Load Power Consumption

#### Table 8. No-Load Power Consumption

Vin (V)	85	115	130	150	180	200	230	265
Pin (mW)	27	36.7	43.12	35.02	40.47	39.33	48.2	59.1

#### 3.2.4 Thermal Test

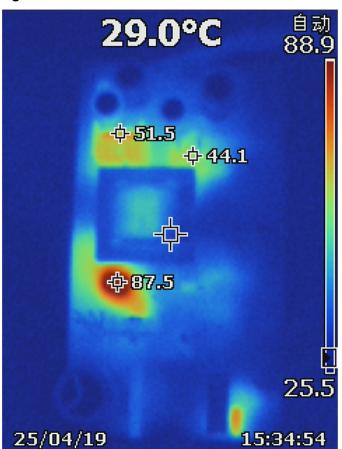


Figure 4. Thermal Test Under 230-V AC and Full Load

The thermal test shows a top view of the board because all of the power components are on the top layer. The output load is 5 V-2 A and 12 V-2.5 A and runs for 30 minutes. The ambient temperature was 22.5°C, open frame.



#### 3.3 Waveforms on Key Components

#### 3.3.1 V<sub>DS</sub> Waveform of Primary MOSFET

Figure 5 shows the test under 85-V AC input and full load.



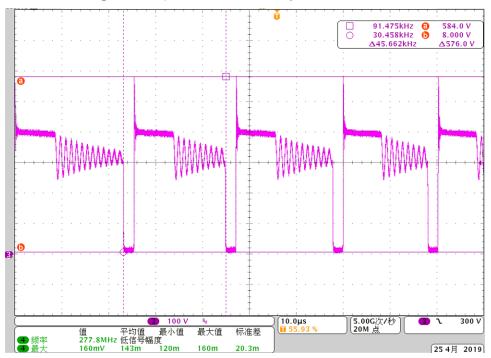
## Figure 5. V<sub>DS</sub> Under 85-V AC Input and Full Load

Figure 6 shows the test under 115-V AC input and full load.



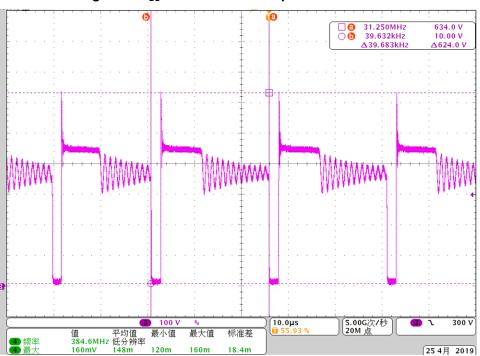
# Figure 6. $V_{DS}$ Under 115-V AC Input and Full Load

Figure 7 shows the test under 230-V AC input and full load.



#### Figure 7. $V_{DS}$ Under 230-V AC Input and Full Load

Figure 8 shows the test under 265-V AC input and full load.

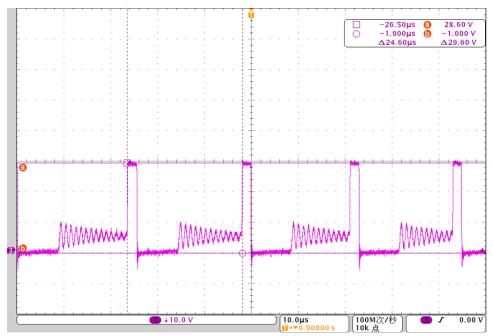


## Figure 8. V<sub>DS</sub> Under 265-V AC Input and Full Load



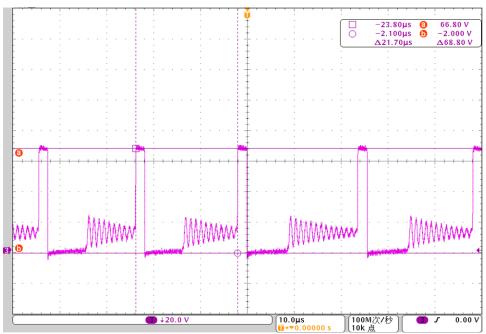
#### 3.3.2 Secondary Rectifier Diode Stress V<sub>DD</sub>

Figure 9 shows the test under 265-V AC input and full load.



#### Figure 9. V<sub>DD</sub>of 5 V Under 265-V AC Input and Full Load

Figure 10. V<sub>DD</sub>of 12 V Under 265-V AC Input and Full Load





#### 3.3.3 Output Voltage Ripple

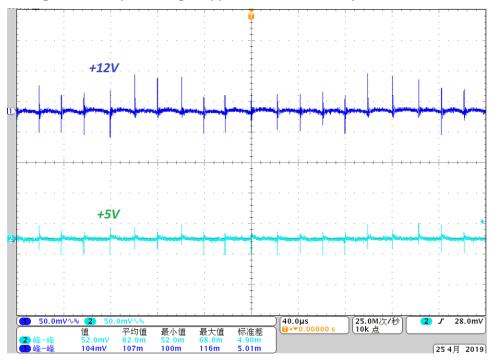
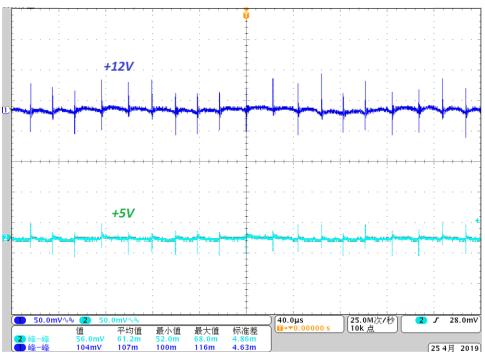


Figure 11. Output Voltage Ripple Under 85-V AC Input and Full Load

Figure 12. Output Voltage Ripple Under 115-V AC Input and Full Load



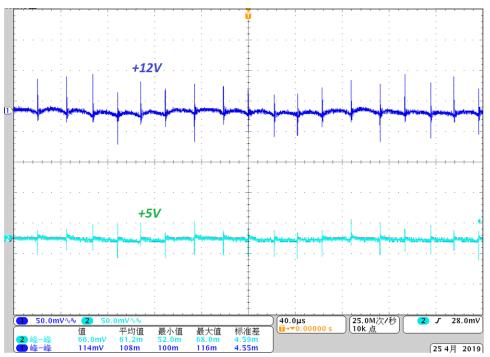
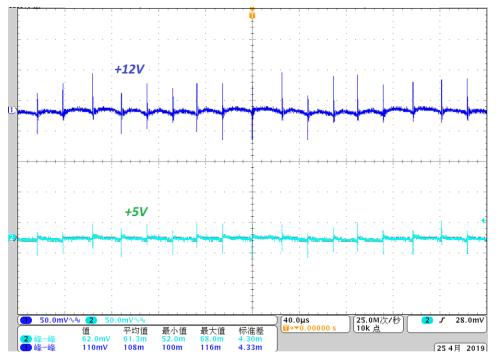


Figure 13. Output Voltage Ripple Under 230-V AC Input and Full Load

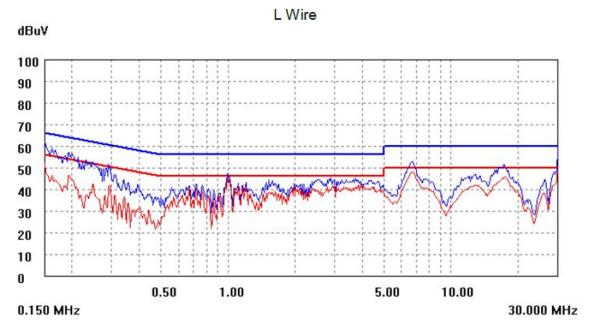
Figure 14. Output Voltage Ripple Under 265-V AC Input and Full Load



#### 3.3.4 Conducted Emission (EN55022 Class B)

Figure 15 shows the test under 230-V AC/50 Hz and full load.

#### Figure 15. Conducted Emission Test Under 230-V AC/50-Hz Input and Full Load





#### 4 Design Files

#### 4.1 Schematics

To download the schematics, see the design files at TIDA-010058.

#### 4.2 Bill of Materials

To download the bill of materials (BOM), see the design files at TIDA-010058.

#### 4.3 PCB Layout Recommendations

To increase the reliability and feasibility of the project, use the following guidelines:

- Minimize stray capacitance on the VS node.
- Place the voltage sense resistors R17 and R18 close to the VS pin.
- Connect the high-voltage input to a non-switching source of high voltage not to the MOSFET drain to avoid injecting high-frequency capacitive current pulses into the device.
- Connect the main power loop ground and the UCC28742 ground through a single point connection at the C2 ground pin.
- Arrange the components to minimize the loop areas of the switching currents as much as possible.

#### 4.3.1 Layout Prints

To download the layer plots, see the design files at TIDA-010058.

#### 4.4 Altium Project

To download the Altium Designer® project files, see the design files at TIDA-010058.

#### 4.5 Gerber Files

To download the Gerber files, see the design files at TIDA-010058.

#### 4.6 Assembly Drawings

To download the assembly drawings, see the design files at TIDA-010058.

#### 5 Related Documentation

1. Texas Instruments, UCC28742 High-Efficiency Flyback Controller With Optocoupler Feedback Data Sheet

#### 5.1 Trademarks

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#### 6 About the Author

**YUAN (JASON) TAO** is a systems engineer at Texas Instruments, where he is responsible for developing reference design solutions for the industrial segment. Yuan brings to this role his extensive experience in power electronics, high-frequency DC/DC, AC/DC converters, and analog circuit design. Yuan earned his master of IC design and manufacture from Shanghai Jiao Tong University in 2007.

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